Special Issue

Processes in Electrical, Electronics and Information Engineering

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This Special Issue on "Processes in Electrical, Electronics and Information Engineering" seeks highquality works focusing on the latest novel advances in membrane technology for both gas and liquid separation. Topics include but are not limited to:

- Electrical and electronics engineering
- Communications and computer systems
- Automation and control engineering
- Informatics and computer sciences
- Information engineering

Guest Editor

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Deadline for manuscript submissions

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Message from the Editor-in-Chief

You are invited to contribute either a research article or a comprehensive review for consideration and publication in *Processes* (ISSN 2227-9717). *Processes* is published in open access format – research articles, reviews, and other content are released on the internet immediately after acceptance. The scientific community and the general public have unlimited, free access to the content. As an open access journal, *Processes* is supported by the authors and their institutes through the payment of article processing charges (APCs) for accepted papers. We would be pleased to welcome you as one of our authors.

Editor-in-Chief

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